## S108T01/S108T02/S208T01/S208T02

# S108T01/S108T02 S208T01/S208T02

#### Features

- 1. Low profile type (height : 16mm)
- 2. Built-in zero-cross circuit (S108T02/S208T02)
- 3. RMS ON-state current IT : MAX. 8Arms
- 4. Approved by TÜV, No. R9750791 (S208TY1/S208TY2) Input-Output : Basic Insulation

## Applications

- 1. Programmable controllers
- 2. Air conditioners
- 3. Copiers
- 4. Automatic vending machines

#### ■ Model line-ups

	For 100V lines	For 200V lines
No zero-cross circuit	S108T01	S208T01
Built-in zero-cross circuit	S108T02	S208T02

	Absolute	Maximu	m Ratir	ngs (*	Ta=25°C)
Parameter		Symbol	Rating	Unit	
ut	Forward current		IF	50	mA
Input	Reverse voltage		VR	6	V
	RMS ON-state current		Ιт	*18	Arms
	*2 Peak one cycle surge current		Isurge	80	А
	Repetitive peak OFF- state voltage	S108T01 S108T02 S208T01 S208T02	Vdrm	400 600	v
Output	Non-repetitive peak OFF- state voltage	S108T01 S108T02 S208T01 S208T02	Vdsm	400	v
	Critical rate of rise of ON-state current		dIt/dt	50	A/µs
	Operating frequency		f	45 to 65	Hz
Operating temperature		Topr	-25 to +100	°C	
Storage temperature		Tstg	-30 to +125	°C	
	*3 Isolation vo	ltage	Viso	3.0	kVrms
*4 Soldering temperature		T <sub>sol</sub>	260	°C	

\*1 Refer to Fig.2, Fig.3

\*2 60Hz sine wave, start at Tj=25°C

\*3 Isolation voltage measuring method (1) Dielectric withstand voltage tester with zero cross circuit shall be used.

(2) The applied voltage waveform shall be sine wave.(3) Voltage shall be applied between input and output. (Input and output terminals shall be shorted respectively.)

(4) AC 60Hz, 1min, 40 to 60% RH.

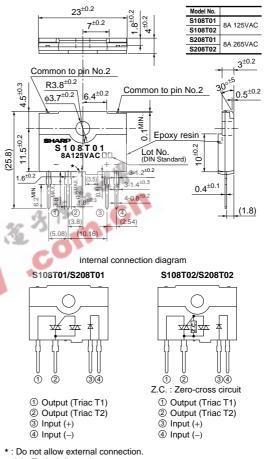
\*4 For 10s

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## Low Profile Type **Solid State Relays**

## Outline Dimensions

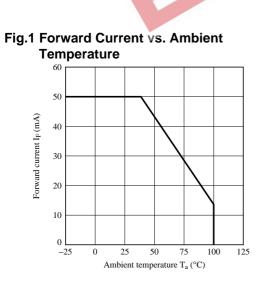
(Unit:mm)

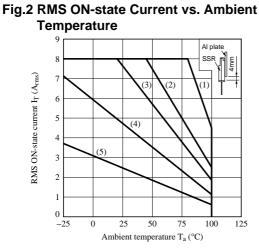


\* ( ): Typical dimensions

## S108T01/S108T02/S208T01/S208T02

Symbol VF IR IDRM	Conditions Ir=20mA Vr=3V	MIN. _ _	TYP. 1.2 -	MAX.	Unit V
Ir	V <sub>R</sub> =3V	-			v
		_			
DRM		v 1		1×10 <sup>-4</sup>	A
	VD=VDRM		1×10 <sup>-4</sup>	A	
VT	IT=2Arms, Resistance load, IF=20mA	-	_	1.5	Vrms
	_	-	-		mA
			-	-	V/µs
(dV/dt)c		5	-	-	V/µs
IFT		-	_	8	mA
			_	35	V
Riso		1×10 <sup>10</sup>	-	-	Ω
				1	
ton	,				ms
	VD=200Vrms, AC50Hz, IT=2Arms,			10	
	Resistance load, IF=20mA				
	VD=100Vrms, AC50Hz, IT=2Arms,	30-32 9		10	
t	Resistance load, IF=20mA				ma
Loff	VD=200Vrms, AC50Hz, IT=2Arms,				ms
	Resistance load, IF=20mA				
Rth(j-c)	- * 3 13		4.5	-	°C/W
Rth(j-a)	CO	<u>.</u>	40		
	IH dV/dt (dV/dt)c IFT Vox Riso ton toff Rth(j-c)	$\begin{tabular}{ c c c c c c } \hline I_H & - & & & & & & & & & & & & & & & & & $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $







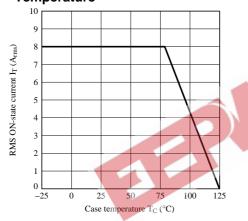
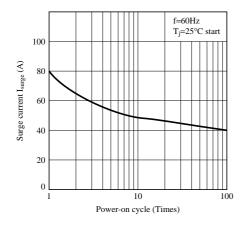


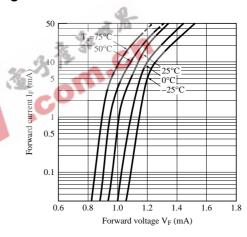
Fig.5 Surge Current vs. Power-on Cycle



## S108T01/S108T02/S208T01/S208T02

- (1) With infinite heat sink
- (2) With heat sink (200×200×2mm Al plate)
- (3) With heat sink (100×100×2mm Al plate)
- (4) With heat sink (50×50×2mm Al plate)
- (5) Without heat sink
- (Note) With the Al heat sink set up vertically, tighten the device with a torque of 0.4N·m and apply thermal conductive silicone grease on the mounting face of heat sink. Forced cooling shall not be carried out. (Please use an isolation sheet if necessary.)

Fig.4 Forward Current vs. Forward Voltage



S108T01/S108T02/S208T01/S208T02

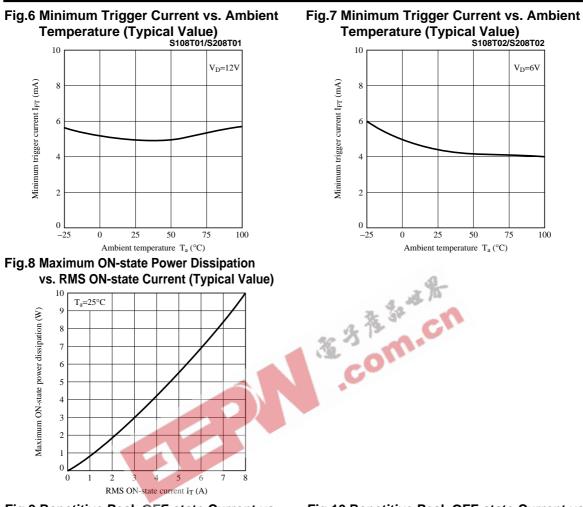


Fig.9 Repetitive Peak OFF-state Current vs. Ambient Temperature

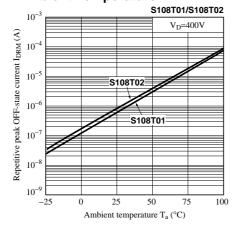
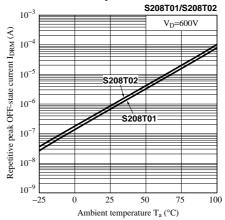


Fig.10 Repetitive Peak OFF-state Current vs. Ambient Temperature



## **Application Circuits**

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